

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	3811	(257/660,659,99,E33.056).CCLS.	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/19 08:43
L2	410742	((microchip micro adj chip chip integrated adj circuit die dice ic semiconductor adj (device element structure component module))((led ((light radiation radiating) near (emitting emissive)) (optoelectronic opto adj electronic) (EL luminescen\$2 electroluminescen\$2 electr\$4 near (luminescen\$2 optic\$3)) near (device diode structure element package) OLED laser)) with (((printed adj circuit PC wiring) adj (board card module)) pcb PWB motherboard mother adj board carrier substrate wafer base)	US-PGPUB; USPAT	OR	ON	2006/10/19 08:58
L3	593767	((cu copper) adj foil shield\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/10/19 08:52
L4	126823	(rectang\$4 square) with (electrode contact terminal wiring)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/10/19 08:54
L5	106	2 same 3 same 4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/10/19 08:54
L6	5	5 and 1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/10/19 08:57

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L7	122393	2.clm.	US-PGPUB; USPAT	OR	ON	2006/10/19 08:58
L8	79270	3.clm.	US-PGPUB; USPAT	OR	ON	2006/10/19 08:58
L9	17188	4.clm.	US-PGPUB; USPAT	OR	ON	2006/10/19 08:58
L10	7	7 same 8 same 9	US-PGPUB; USPAT	OR	ON	2006/10/19 08:58
L11	47	7 and 8 and 9	US-PGPUB; USPAT	OR	ON	2006/10/19 08:58
L12	6	11 and 1	US-PGPUB; USPAT	OR	ON	2006/10/19 08:59